

PRODUCT SPECIFICATION

1.45” TN TFT LCD MODULE  
MODEL: YDP LCD TN 12 145 S



- < ◇ > Preliminary Specification
- < ◆ > Finally Specification

CUSTOMER’S APPROVAL	
CUSTOMER :	
SIGNATURE:	DATE:

APPROVED BY	PM REVIEWED	PD REVIEWED	PREPARED BY
_____	<div>TFT W. S. L 20241126</div>	_____	<div>TFT Funny 20241126</div>

knitter-switch

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**Revision History**

Revision	Date	Originator	Detail	Remarks
1.0	2024.07.31	LL	Initial Release	
1.1	2024.11.26	ZFY	Modify View Direction	P4

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## 1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

## 2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	1.45"	
LCD type	TN TFT	
Display Mode	Transmissive /Normally White	
Resolution	60 RGB x160	Pixels
View Direction	(12 o'clock)	Best Image
Module Outline	15.4(H) x 39.69(V) x 2.1 (D) (Note1 )	mm
Active Area	13.104(H) x 34.944(V)	mm
Pixel Size	0.2184(H) x 0.2184(V)	um
Pixel Arrangement	RGB Vertical stripe	
Display Colors	262K	
Interface	4 Wire SPI	
With or without touch panel	Without	
Driver IC	GC9107	-
Operating Temperature	<b>-20~70</b>	°C
Storage Temperature	<b>-30~80</b>	°C
Weight	TBD	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

## 3. Absolute Maximum Ratings

GND=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VDD	-0.3	4.6	V
Storage temperature	T <sub>STG</sub>	<b>-30</b>	<b>+80</b>	°C
Operating temperature	T <sub>OP</sub>	<b>-20</b>	<b>+70</b>	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

#### 4. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage	VDD	2.9	3.0	3.1	V
Logic Low input voltage	V <sub>IL</sub>	GND	-	0.3*VDD	V
Logic High input voltage	V <sub>IH</sub>	0.7*VDD	-	VDD	V
Logic Low output voltage	V <sub>OL</sub>	GND	-	0.2*VDD	V
Logic High output voltage	V <sub>OH</sub>	0.8*VDD	-	VDD	V
Current Consumption All black	I <sub>DD</sub>	-	TBD	-	mA

#### 5. Backlight Characteristic

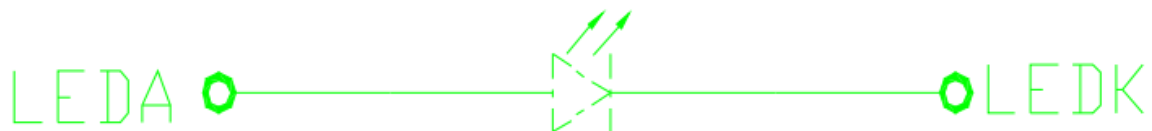
##### 5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V <sub>F</sub>	T <sub>a</sub> =25 °C, I <sub>F</sub> =20mA/LED	2.8	<b>3.0</b>	3.4	V
Forward Current	I <sub>F</sub>	T <sub>a</sub> =25 °C, V <sub>F</sub> =3.0V/LED	-	<b>20</b>	-	mA
Power dissipation	P <sub>D</sub>		-	<b>60</b>	-	mW
Uniformity	Avg		-	80	-	%
LED working life(25°C)	-		-	(30,000)	-	Hrs
Drive method	<b>Constant current</b>					
LED Configuration	1 White LED					

Note1: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at T<sub>a</sub>=25±2 °C, 60%RH±5%, I<sub>F</sub>=20mA/LED.

##### 5.2. Backlighting circuit



## 6. Optical Characteristics

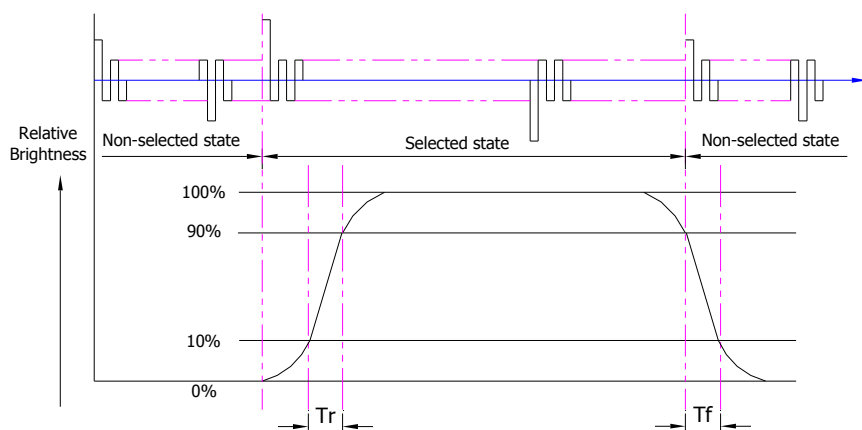
### 6.1. Optical Characteristics

Ta=25°C, VDD=2.8V

Backlight On (Transmissive Mode)	Item		Symbol	Condition	Specification			Unit
					Min.	Typ.	Max.	
	Luminance on TFT( $I_f$ =20mA/LED)		Lv	Normally viewing angle $\theta_x = \phi_y =0^\circ$	240	300	-	cd/m <sup>2</sup>
	Contrast ratio(See 6.3)		CR		500	800	-	
	Response time (See 6.2)		TR+TF		-	30	40	ms
	Chromaticity Transmissive (See 6.5)	Red	XR		-	TBD	-	
			YR		-	TBD	-	
		Green	XG		-	TBD	-	
			YG		-	TBD	-	
		Blue	XB		-	TBD	-	
			YB		-	TBD	-	
		White	XW		-	TBD	-	
			YW		-	TBD	-	
	Viewing Angle (See 6.4)	Horizontal	$\theta_{x+}$	Center CR≥10	-	50	-	Deg.
			$\theta_{x-}$		-	50	-	
Vertical		$\phi_{y+}$	-		(40)	-		
		$\phi_{y-}$	-		(50)	-		
	NTSC Ratio(Gamut)				-	-	-	%

### 6.2. Definition of Response Time

#### 6.2.1. Normally Black Type (Negative)

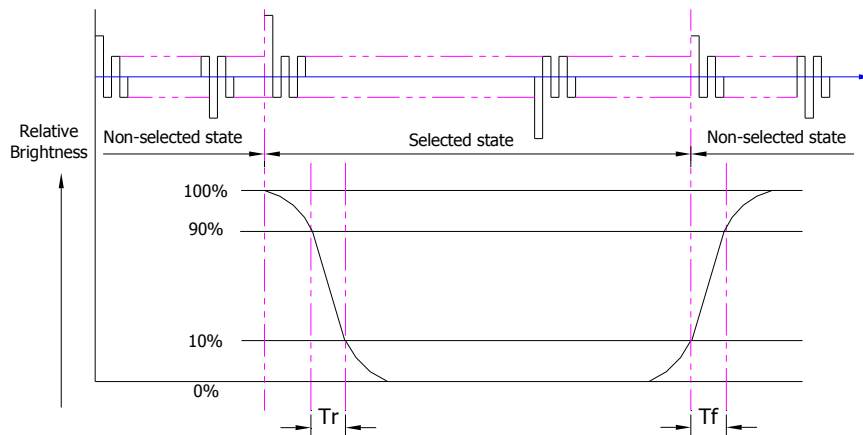


$T_r$  is the time it takes to change from non-selected state with relative luminance 10% to selected state with relative luminance 90%;

$T_f$  is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

### 6.2.2. Normally White Type (Positive)



Tr is the time it takes to change from non-selected state with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

### 6.3. Definition of Contrast Ratio

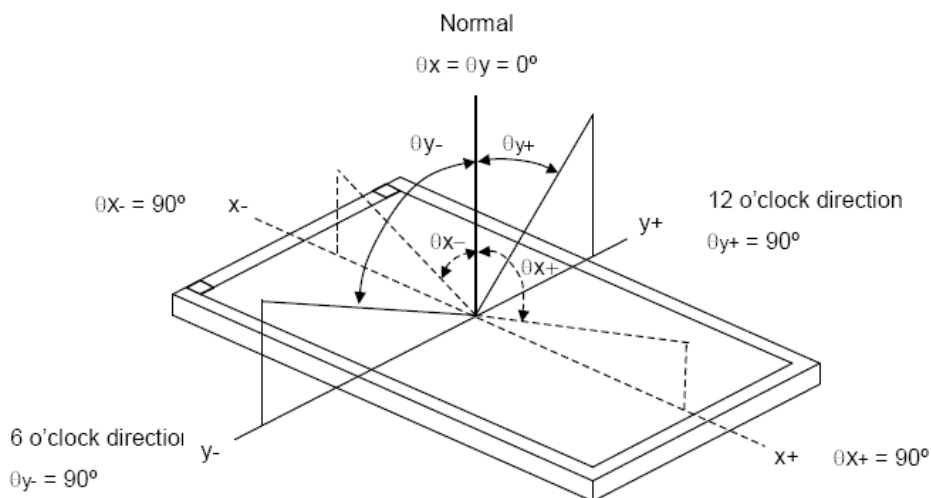
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

### 6.4. Definition of Viewing Angles



Measuring machine: LCD-5100 or EQUI

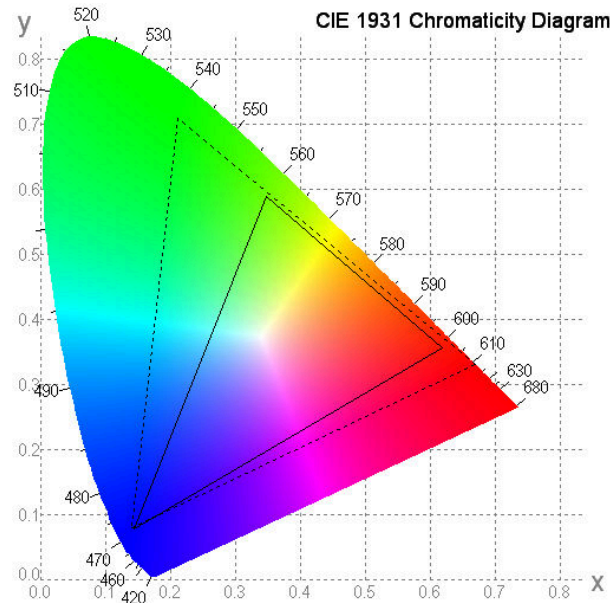
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## 6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)



## 6.6. Definition of Surface Luminance, Uniformity and Transmittance

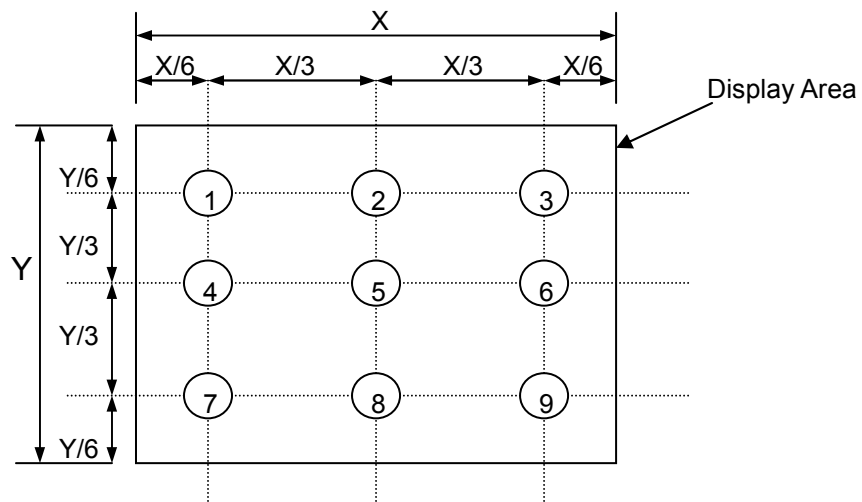
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

6.6.1. Surface Luminance:  $L_V = \text{average } (L_{P1}:L_{P9})$

6.6.2. Uniformity = Minimal ( $L_{P1}:L_{P9}$ ) / Maximal ( $L_{P1}:L_{P9}$ ) \* 100%

6.6.3. Transmittance =  $L_V$  on LCD /  $L_V$  on Backlight \* 100%

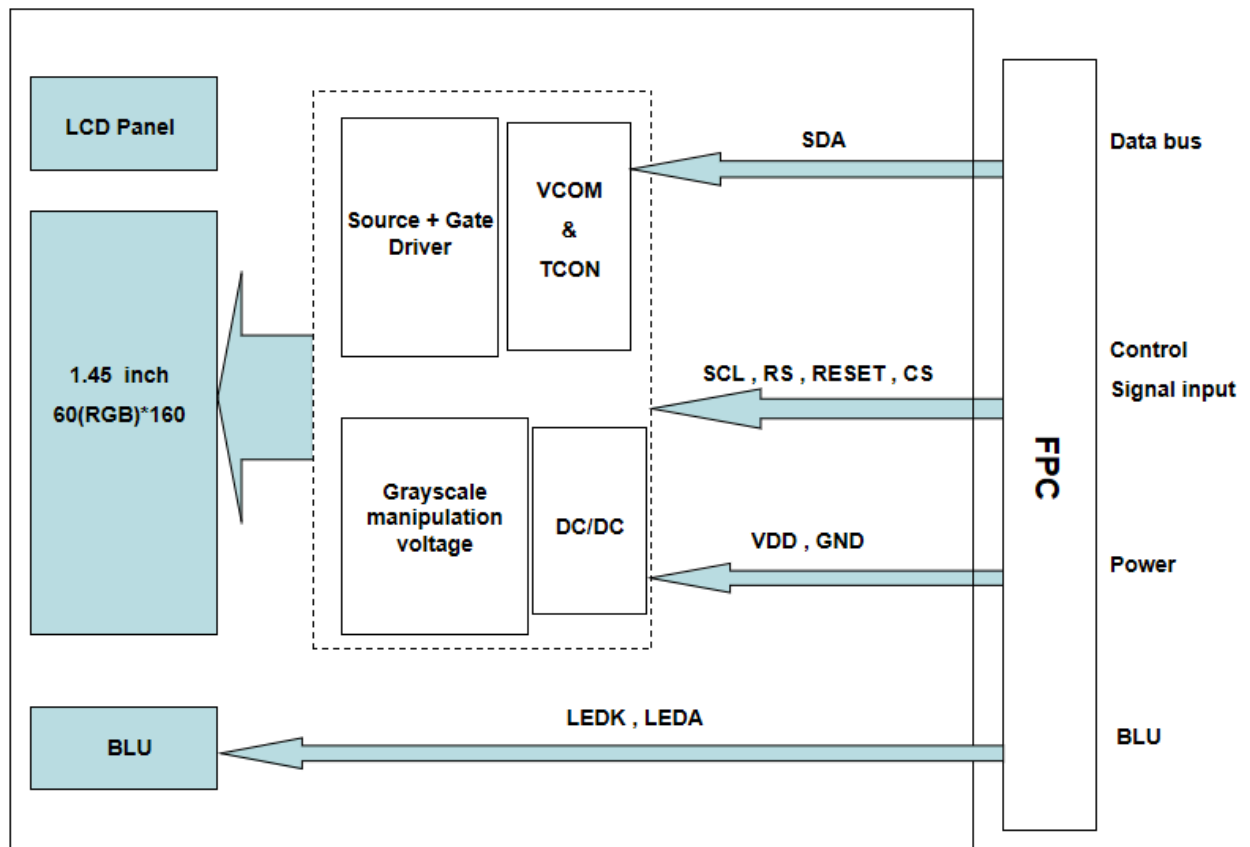
Note: Measuring machine: BM-7





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## 7. Block Diagram and Power Supply



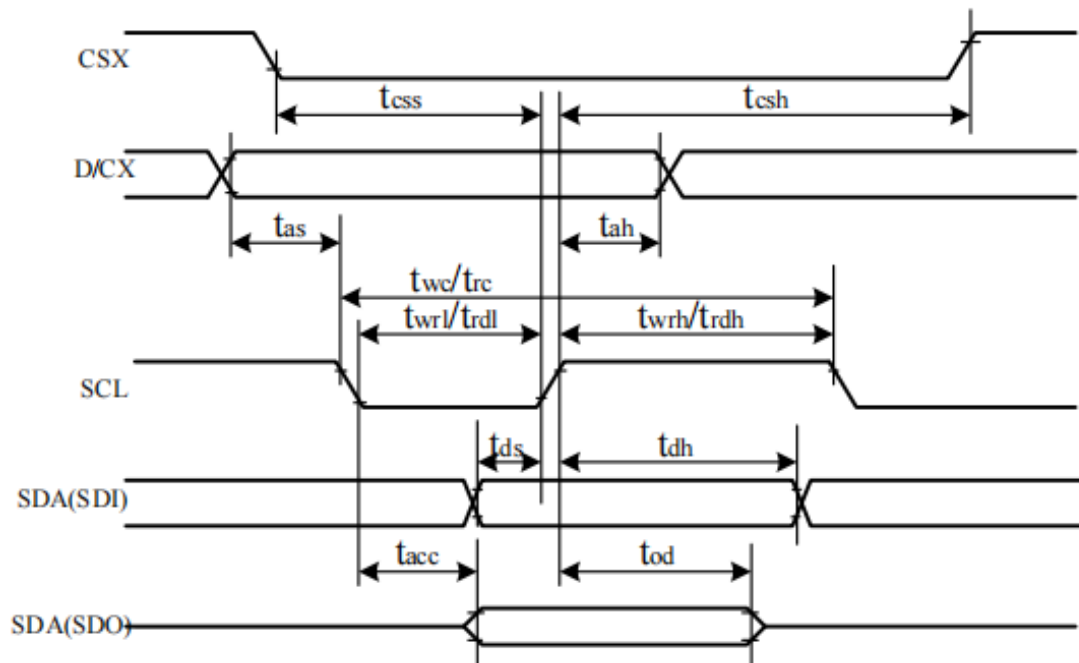
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## 8. Interface Pins Definition

No.	Symbol	Function	Remark
1	NC	No Connection	
2	NC	No Connection	
3	SDA	SPI interface input/output pin	
4	SCL	This pin is used to be serial interface clock	
5	RS	Display data/command selection pin in 4-line serial interface	
6	RESET	This signal will reset the device,Signal is active low	
7	CS	Chip selection pin,Low enable,High disable	
8	GND	Ground	
9	NC	No Connection	
10	VDD	Power Supply for Analog	
11	LEDK	LED Canthode	
12	LEDA	LED Anode	
13	GND	Ground	

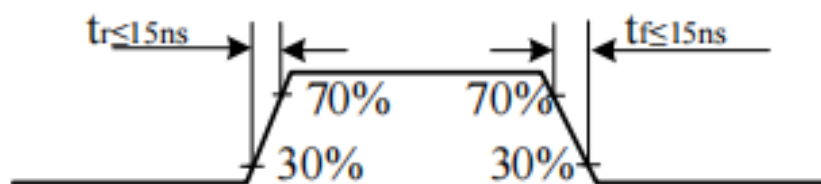
## 9. AC Characteristics

### 9.1. Display Serial Interface Timing Characteristics (4-line SPI system)



Signal	Symbol	Parameter	min	max	Unit	Description
SCL	tscycw	Serial Clock Cycle (Write)	10	-	ns	
	tshw	SCL "H" Pulse Width (Write)	5	-	ns	
	tslw	SCL "L" Pulse Width (Write)	5	-	ns	
	tscycr	Serial Clock Cycle (Read)	150	-	ns	
	tshr	SCL "H" Pulse Width (Read)	60	-	ns	
	tslr	SCL "L" Pulse Width (Read)	60	-	ns	
SDA/SDI (Input)	tsds	Data setup time (Write)	5	-	ns	
	tsdh	Data hold time (Write)	5	-	ns	
SDA/SDO (Output)	tacc	Access time (Read)	10	-	ns	
	toh	Output disable time (Read)	10	50	ns	
CSX	tsc	SCL-CSX	10	-	ns	
	tch	CSX "H" Pulse Width	20	-	ns	
	tcss	CSX-SCL Time	40	-	ns	
	tchsh		10	-	ns	

Note:  $T_a = 25^\circ\text{C}$ ,  $V_{DDI}=1.65\text{V to }3.3\text{V}$ ,  $V_{DD}=2.5\text{V to }3.3\text{V}$ ,  $V_{SSA}=V_{SSR}=0\text{V}$



## 9.2. Power ON/OFF Sequence

IOVCC and VCI can be applied in any order.

VCI and IOVCC can be power down in any order.

During power off, if LCD is in the Sleep Out mode, VCI and IOVCC must be powered down minimum 120msec after RESX has been released.

During power off, if LCD is in the Sleep In mode, IOVCC or VCI can be powered down minimum 0msec after RESX has been released.

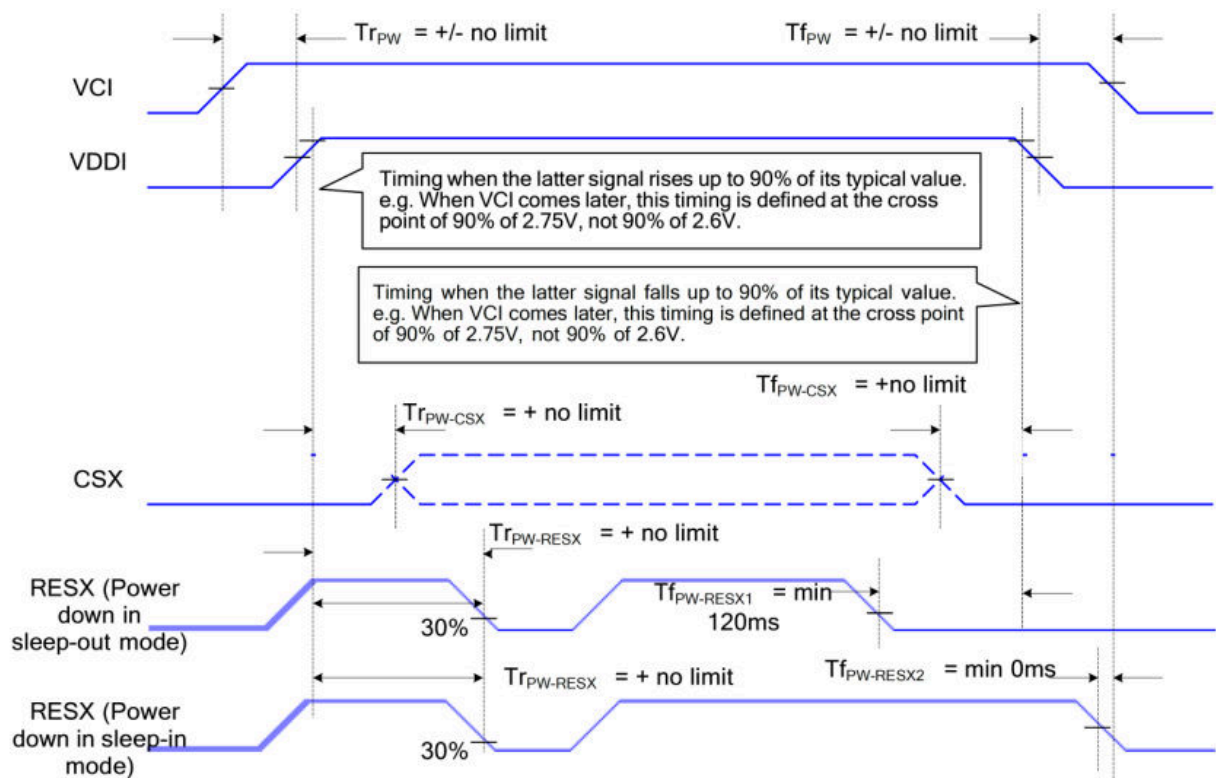
CSX can be applied at any timing or can be permanently grounded. RESX has priority over CSX.

*Note 1: There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.*

*Note 2: There will be no abnormal visible effects on the display between end of Power On Sequence and before receiving Sleep Out command. Also between receiving Sleep In command and Power Off Sequence.*

*Note 3: If RESX line is not held stable by host during Power On Sequence as defined in the sequence below, then it will be necessary to apply a Hardware Reset (RESX) after Host Power On Sequence is complete to ensure correct operation. Otherwise function is not guaranteed.*

The power on/off sequence is illustrated below



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## **10. Quality Assurance**

### **10.1.Purpose**

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

### **10.2.Standard for Quality Test**

#### 10.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

#### 10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5

Electrical functional: AQL 0.65

#### 10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

### **10.3.Nonconforming Analysis & Disposition**

#### 10.3.1. Nonconforming analysis:

10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.

10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

10.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.

#### 10.3.2. Disposition of nonconforming:

10.3.2.1. Non-conforming product over PPM level will be replaced.

10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

### **10.4.Agreement Items**

Shall negotiate with customer if the following situation occurs:

10.4.1. There is any discrepancy in standard of quality assurance.

10.4.2. Additional requirement to be added in product specification.

10.4.3. Any other special problem.

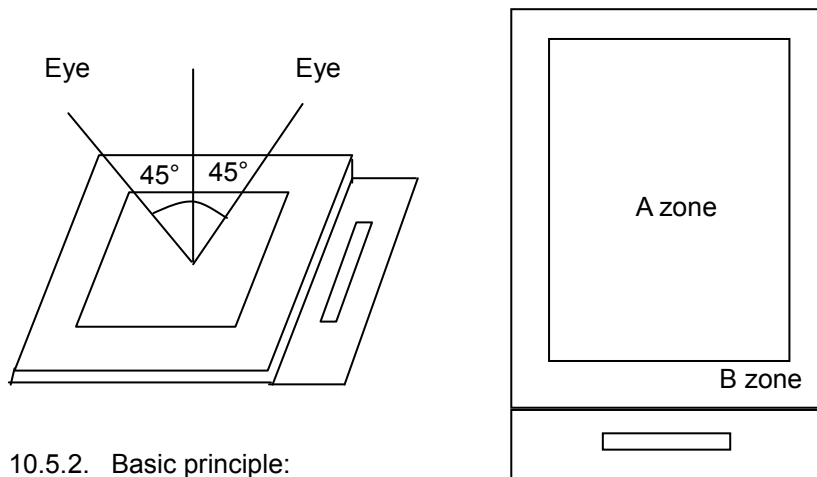
### **10.5.Standard of the Product Visual Inspection**

#### 10.5.1. Appearance inspection:

10.5.1.1. The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,

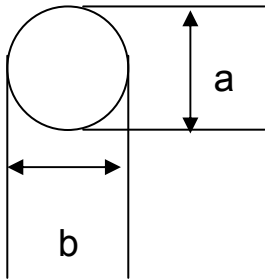


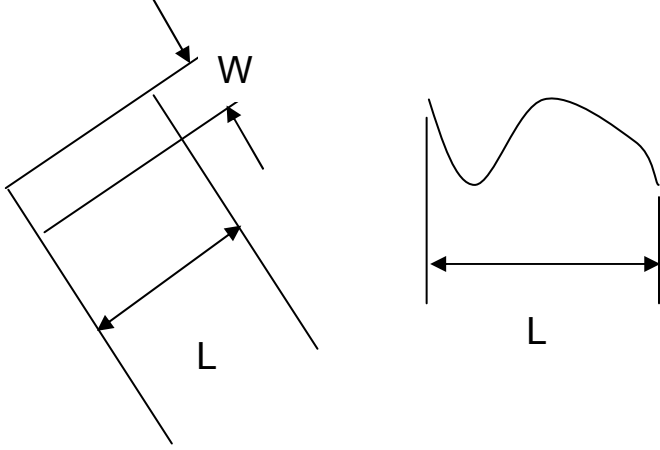
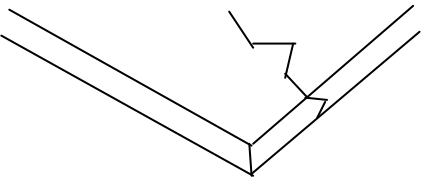
10.5.2. Basic principle:

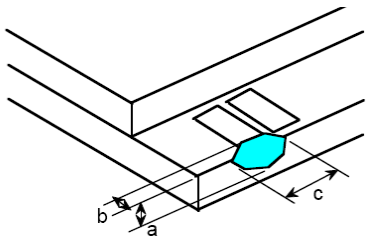
10.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

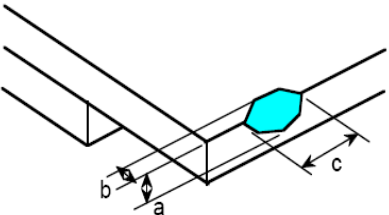
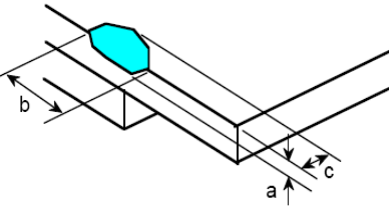
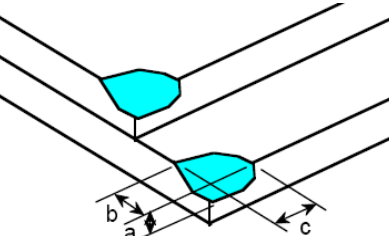
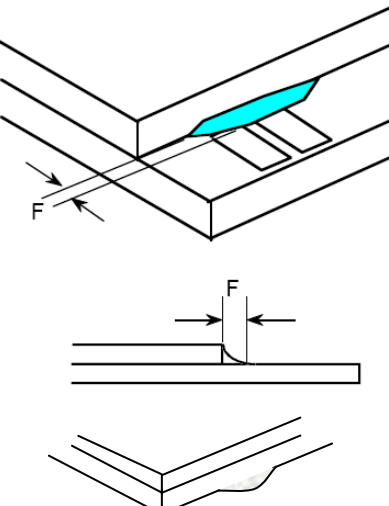
10.5.2.2. New item must be added on time when it is necessary.

10.6. Inspection Specification

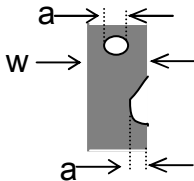
No.	Item	Criteria (Unit: mm)																			
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	 $\varphi = (a + b) / 2$ Distance between 2 defects should more than 3mm apart.	<table><tr><th>Size \ Area</th><th>Acc. Qty</th></tr><tr><td><math>\varphi \leq 0.10</math></td><td>Ignore</td></tr><tr><td><math>0.10 &lt; \varphi \leq 0.15</math></td><td>2</td></tr><tr><td><math>0.15 &lt; \varphi \leq 0.25</math></td><td>1</td></tr><tr><td><math>0.25 &lt; \varphi</math></td><td>0</td></tr><tr><td>Total</td><td>2 no include <math>\varphi \leq 0.10</math></td></tr></table>		Size \ Area	Acc. Qty	$\varphi \leq 0.10$	Ignore	$0.10 < \varphi \leq 0.15$	2	$0.15 < \varphi \leq 0.25$	1	$0.25 < \varphi$	0	Total	2 no include $\varphi \leq 0.10$					
			Size \ Area	Acc. Qty																	
$\varphi \leq 0.10$	Ignore																				
$0.10 < \varphi \leq 0.15$	2																				
$0.15 < \varphi \leq 0.25$	1																				
$0.25 < \varphi$	0																				
Total	2 no include $\varphi \leq 0.10$																				
02	Electrical Defect (Minor defect)	<table><tr><td></td><td>Display Area</td><td>Total</td><td rowspan="4">Note1</td></tr><tr><td>Bright dot</td><td>0</td><td>0</td></tr><tr><td>Dark dot</td><td><math>N \leq 2</math></td><td><math>N \leq 2</math></td></tr><tr><td>Total dot</td><td><math>N \leq 2</math></td><td><math>N \leq 2</math></td></tr><tr><td>Mura</td><td colspan="2">Not visible through 5% ND filters.</td><td>Note2</td></tr></table> Remark: 1. Bright dot caused by scratch and foreign object accords to item 1.				Display Area	Total	Note1	Bright dot	0	0	Dark dot	$N \leq 2$	$N \leq 2$	Total dot	$N \leq 2$	$N \leq 2$	Mura	Not visible through 5% ND filters.		Note2
	Display Area	Total	Note1																		
Bright dot	0	0																			
Dark dot	$N \leq 2$	$N \leq 2$																			
Total dot	$N \leq 2$	$N \leq 2$																			
Mura	Not visible through 5% ND filters.		Note2																		

03	Black and White line Scratch Foreign material (Line type) (Minor defect)	 <table border="1" data-bbox="558 705 1184 1014"> <thead> <tr> <th>Length</th><th>Width</th><th>Acc. Qty</th></tr> </thead> <tbody> <tr> <td>/</td><td><math>W \leq 0.03</math></td><td>Ignore</td></tr> <tr> <td><math>L \leq 2.5</math></td><td><math>0.03 &lt; W \leq 0.05</math></td><td>3</td></tr> <tr> <td><math>L \leq 2.5</math></td><td><math>0.05 &lt; W \leq 0.10</math></td><td>2</td></tr> <tr> <td>/</td><td><math>0.1 &lt; W</math></td><td></td></tr> <tr> <td colspan="2">Total</td><td>3</td></tr> </tbody> </table> <p>Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.</p>	Length	Width	Acc. Qty	/	$W \leq 0.03$	Ignore	$L \leq 2.5$	$0.03 < W \leq 0.05$	3	$L \leq 2.5$	$0.05 < W \leq 0.10$	2	/	$0.1 < W$		Total		3
Length	Width	Acc. Qty																		
/	$W \leq 0.03$	Ignore																		
$L \leq 2.5$	$0.03 < W \leq 0.05$	3																		
$L \leq 2.5$	$0.05 < W \leq 0.10$	2																		
/	$0.1 < W$																			
Total		3																		
04	Glass Crack (Minor defect)	 <p>Crack is potential to enlarge, any type is not allowed.</p>																		

05	Glass Chipping Pad Area: (Minor defect)		<table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td><math>c &gt; 3.0, b &lt; 1.0</math></td><td>1</td></tr><tr><td><math>c &lt; 3.0, b &lt; 1.0</math></td><td>3</td></tr><tr><td colspan="2"><math>a &lt; \text{Glass Thickness}</math></td></tr></table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	3	$a < \text{Glass Thickness}$	
	Length and Width	Acc. Qty									
$c > 3.0, b < 1.0$	1										
$c < 3.0, b < 1.0$	3										
$a < \text{Glass Thickness}$											

06	<p>Glass Chipping Rear of Pad Area: (Minor defect)</p> 	<table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td><math>c &gt; 3.0, b &lt; 1.0</math></td><td>1</td></tr><tr><td><math>c &lt; 3.0, b &lt; 1.0</math></td><td>2</td></tr><tr><td><math>c &lt; 3.0, b &lt; 0.5</math></td><td>4</td></tr><tr><td colspan="2"><math>a &lt; \text{Glass Thickness}</math></td></tr></table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												
07	<p>Glass Chipping Except Pad Area: (Minor defect)</p> 	<table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td><math>c &gt; 3.0, b &lt; 1.0</math></td><td>1</td></tr><tr><td><math>c &lt; 3.0, b &lt; 1.0</math></td><td>2</td></tr><tr><td><math>c &lt; 3.0, b &lt; 0.5</math></td><td>4</td></tr><tr><td colspan="2"><math>a &lt; \text{Glass Thickness}</math></td></tr></table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												
08	<p>Glass Corner Chipping: (Minor defect)</p> 	<table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td><math>c &lt; 3.0, b &lt; 3.0</math></td><td>Ignore</td></tr><tr><td colspan="2"><math>a &lt; \text{Glass Thickness}</math></td></tr></table>	Length and Width	Acc. Qty	$c < 3.0, b < 3.0$	Ignore	$a < \text{Glass Thickness}$					
Length and Width	Acc. Qty											
$c < 3.0, b < 3.0$	Ignore											
$a < \text{Glass Thickness}$												
09	<p>Glass Burr: (Minor defect)</p> 	<table><tr><th>Length</th><th>Acc. Qty</th></tr><tr><td><math>F &lt; 1.0</math></td><td>Ignore</td></tr></table> <p>Glass burr don't affect assemble and module dimension.</p>	Length	Acc. Qty	$F < 1.0$	Ignore						
Length	Acc. Qty											
$F < 1.0$	Ignore											



10	FPC Defect: (Minor defect) 	10.1 Dent, pinhole width $a < w/3$ . (w: circuitry width.) 10.2 Open circuit is unacceptable. 10.3 No oxidation, contamination and distortion.										
11	Bubble on Polarizer (Minor defect)	<table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td><math>\phi \leq 0.20</math></td><td>Ignore</td></tr><tr><td><math>0.20 &lt; \phi \leq 0.30</math></td><td>4</td></tr><tr><td><math>0.30 &lt; \phi \leq 0.50</math></td><td>1</td></tr><tr><td><math>0.50 &lt; \phi</math></td><td>None</td></tr></table>	Diameter	Acc. Qty	$\phi \leq 0.20$	Ignore	$0.20 < \phi \leq 0.30$	4	$0.30 < \phi \leq 0.50$	1	$0.50 < \phi$	None
Diameter	Acc. Qty											
$\phi \leq 0.20$	Ignore											
$0.20 < \phi \leq 0.30$	4											
$0.30 < \phi \leq 0.50$	1											
$0.50 < \phi$	None											
12	Dent on Polarizer (Minor defect)	<table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td><math>\phi \leq 0.20</math></td><td>Ignore</td></tr><tr><td><math>0.20 &lt; \phi \leq 0.30</math></td><td>4</td></tr><tr><td><math>0.30 &lt; \phi \leq 0.50</math></td><td>1</td></tr><tr><td><math>0.50 &lt; \phi</math></td><td>None</td></tr></table>	Diameter	Acc. Qty	$\phi \leq 0.20$	Ignore	$0.20 < \phi \leq 0.30$	4	$0.30 < \phi \leq 0.50$	1	$0.50 < \phi$	None
Diameter	Acc. Qty											
$\phi \leq 0.20$	Ignore											
$0.20 < \phi \leq 0.30$	4											
$0.30 < \phi \leq 0.50$	1											
$0.50 < \phi$	None											
13	Bezel	13.1 No rust, distortion on the Bezel. 13.2 No visible fingerprints, stains or other contamination.										
14	PCB	14.1 No distortion or contamination on PCB terminals. 14.2 All components on PCB must same as documented on the BOM/component layout. 14.3 Follow IPC-A-600F.										
15	Soldering	Follow IPC-A-610C standard										
16	Electrical Defect (Major defect)	The below defects must be rejected. 16.1 Missing vertical / horizontal segment, 16.2 Abnormal Display. 16.3 No function or no display. 16.4 Current exceeds product specifications. 16.5 LCD viewing angle defect. 16.6 No Backlight. 16.7 Dark Backlight. 16.8 Touch Panel no function.										

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

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## 10.7. Classification of Defects

10.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.

10.7.2. Two minor defects are equal to one major in lot sampling inspection.

## 10.8. Identification/marketing criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

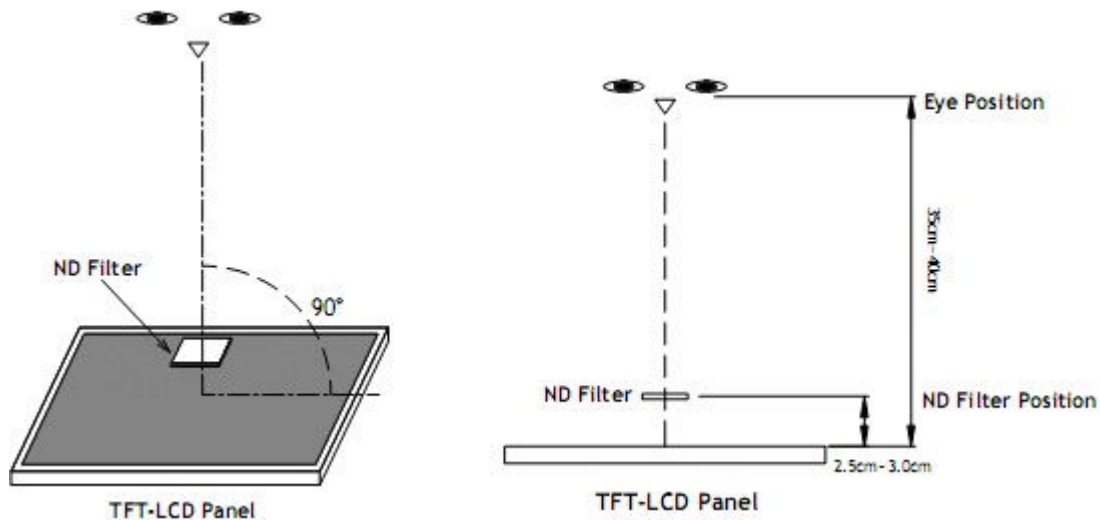
## 10.9. Packaging

10.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.

10.9.2. Modules inside package box should have compliant mark.

10.9.3. All direct package materials shall offer ESD protection.

**Note1:** Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



**Bright dot:** The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is  $350\text{mm} \pm 50\text{mm}$ .

**Dark dot:** Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is  $350\text{mm} \pm 50\text{mm}$ .

**Note2:** Mura on display which appears darker / brighter against background brightness on parts of display area.

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## 11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70℃, 96Hrs	2	GB/T2423.2-2008
2	Low Temperature Operating	-20℃, 96Hrs	2	GB/T2423.1-2008
3	High Humidity Storage	50℃, 85%RH, 96Hrs	2	GB/T2423.3-2016
4	High Temperature Storage	80℃, 96Hrs	2	GB/T2423.2-2008
5	Low Temperature Storage	-30℃, 96Hrs	2	GB/T2423.1-2008
6	Thermal Cycling Test Storage	-10℃, 60min~60℃, 60min, 20 cycles.	2	GB/T2423.22-2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	-	GB/T5170.14-2009
8	Electrical Static Discharge	Air:±4KV 150pF/330Ω 5 times Contact:±2KV 150pF/330Ω 5 times	2	GB/T17626.2-2018
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	-	GB/T2423.7-2018

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

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## 12. Precautions and Warranty

### 12.1. Safety

- 12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

### 12.2. Handling

- 12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

### 12.3. Storage

- 12.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 12.3.2. Strong light exposure causes degradation of polarizer and color filter.

### 12.4. Metal Pin (Apply to Products with Metal Pins)

#### 12.4.1. Pins of LCD and Backlight

- 12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

#### 12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

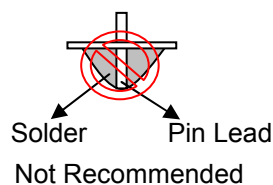
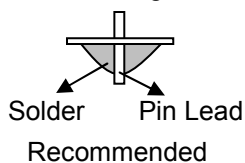
Maximum Solder Temperature: 370℃

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20℃

Typical Soldering Time: ≤3s

#### 12.4.1.3. Solder Wetting



#### 12.4.2. Pins of EL

- 12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

- 12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

#### 12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290℃

Typical Soldering Time: ≤2s

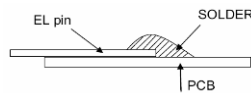
Minimum solder distance from EL lamp (body): 2.0mm

- 12.4.2.4. No horizontal press on the EL leads during soldering.

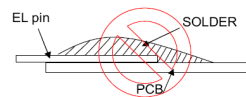
- 12.4.2.5. 180° bend EL leads three times is not allowed.

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#### 12.4.2.6. Solder Wetting

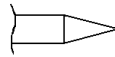


Recommended

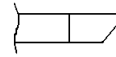


Not Recommended

#### 12.4.2.7. The type of the solder iron:

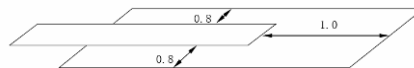


Recommended



Not Recommended

#### 12.4.2.8. Solder Pad



### 12.5. Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear “fractured”.
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. *Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it will develop image sticking due to the TFT structure.*

### 12.6. Static Electricity

- 12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

### 12.7. Limited Warranty

- 12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

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### 13. Packaging

TBD

14. Outline Drawing

